



# Shear Stress Measurements via Elastomeric Micropillar Arrays

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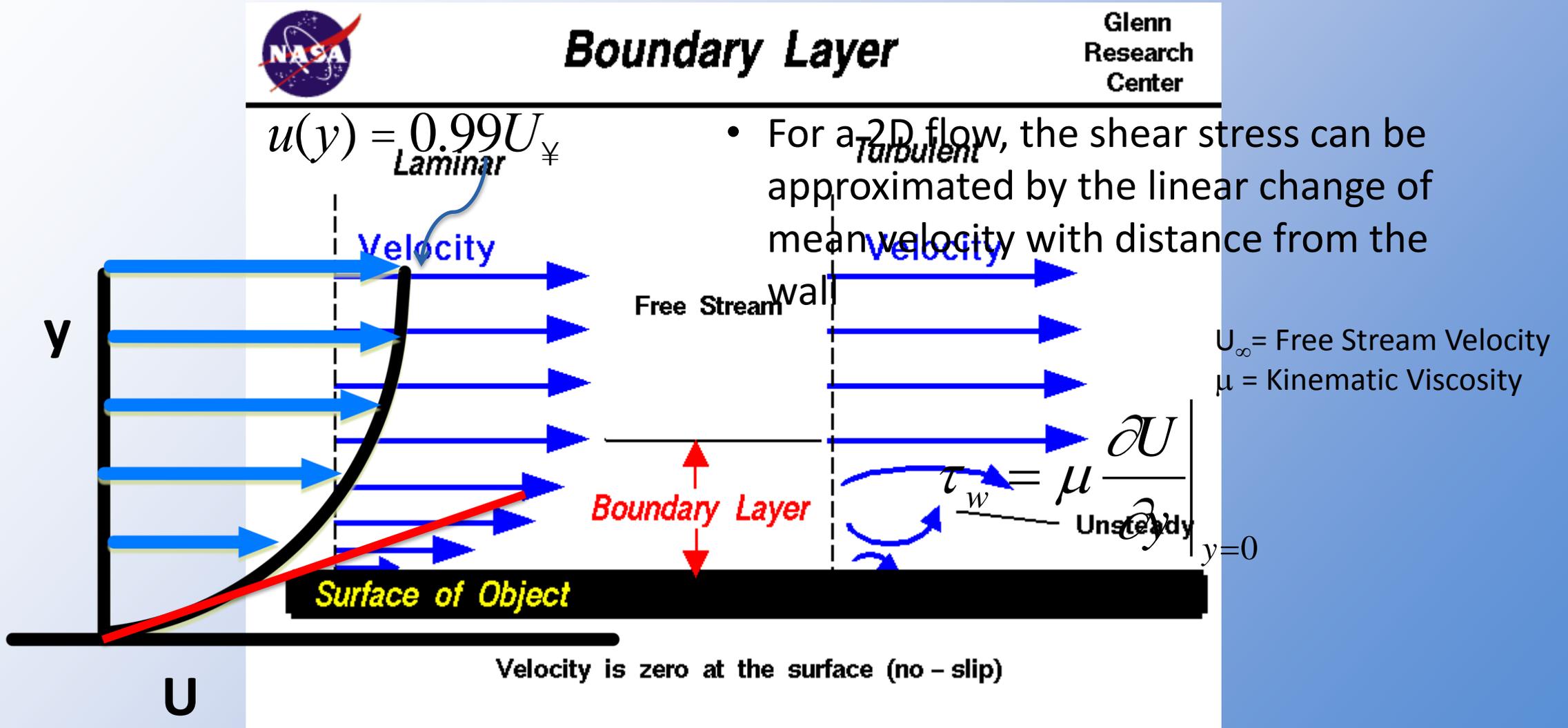
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Sensing and Controlling Motion with Polymeric Materials Symposium

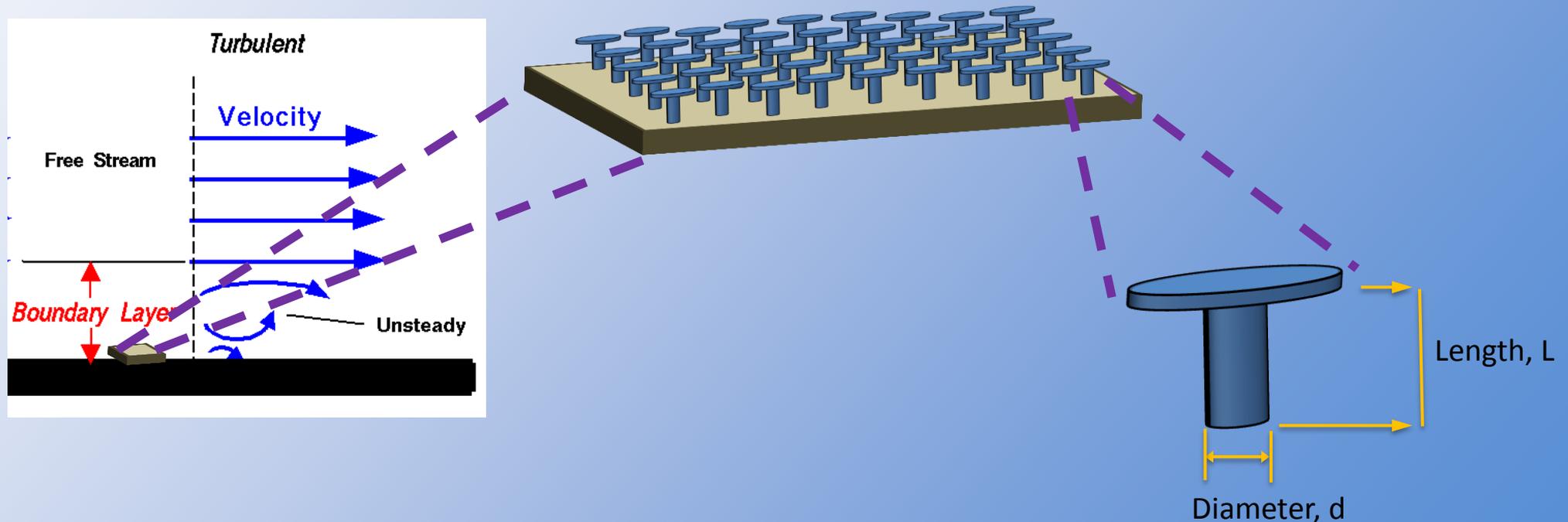
# Airflow & Shear Stress





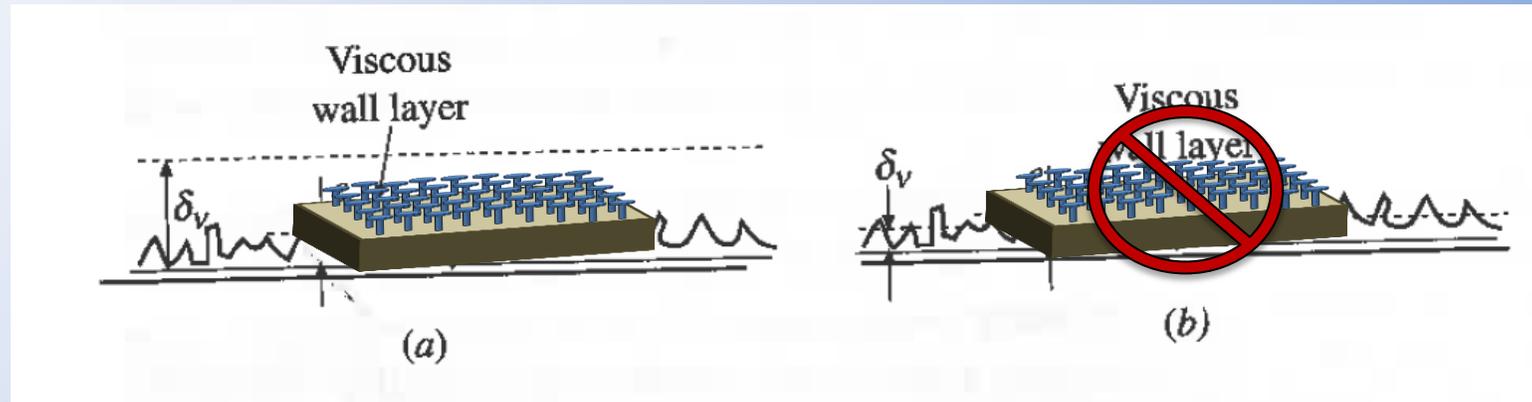
# Research Objective

- The objective of this work is to generate a robust shear stress sensor capable of **making accurate shear stress measurements up to 10 Pa with  $\mu\text{Pa}$  sensitivity** without airflow disruption.



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A Smooth Wall

A Rough Wall

Image from: Potter, Merle C. Fluid Mechanics Demystified. The McGraw Hill Company, New York, 2009, p. 144.



# State-of-the-Art Shear Stress Sensing

## Indirect Measurements

- Hot Wire Anemometer
- Pitot Tube
- Whispering Gallery Mode

## Direct Measurements

- Oil Interference
- MEMS devices

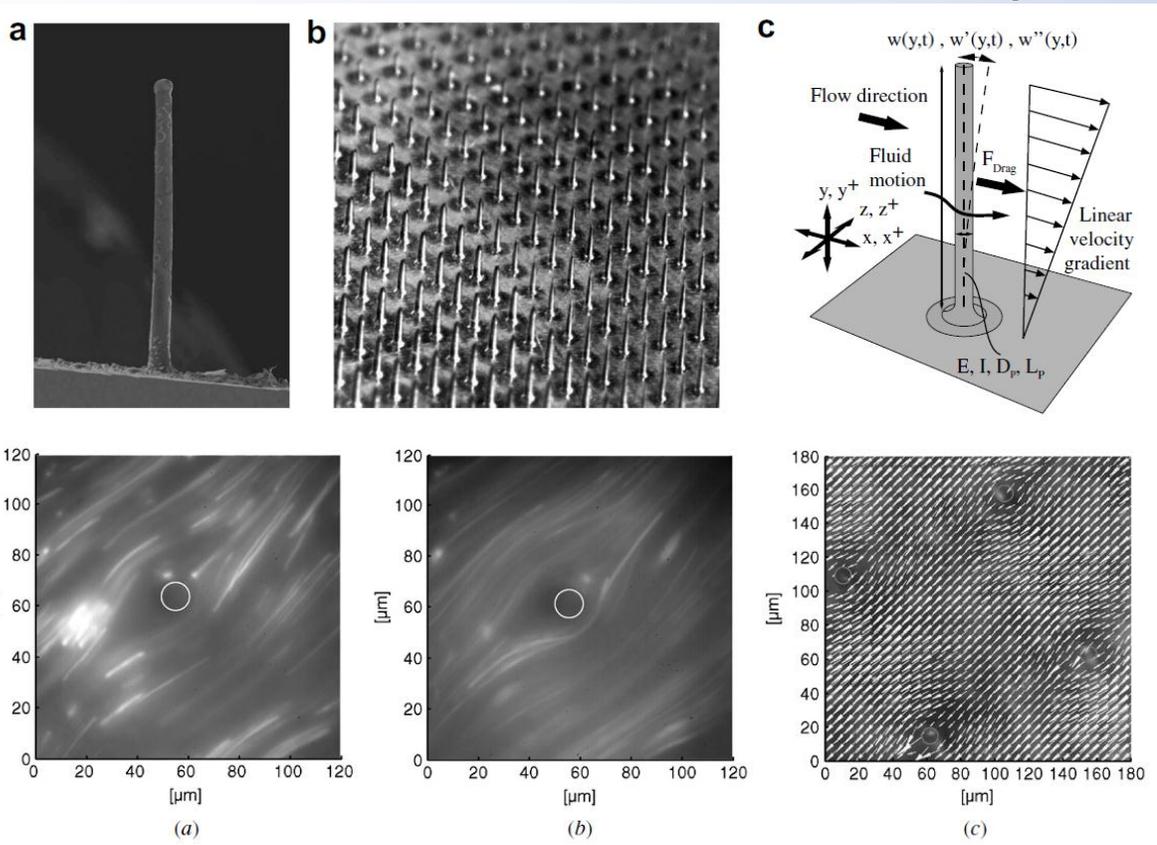
*Current shear stress measurement techniques that minimally impact airflow are difficult to implement, of questionable reliability, and sensitive to environmental factors.*

## **Our approach ... “Capped” Micropost Arrays**

Development of these sensors would alleviate many of these issues enabling shear stress measurement on a variety of surfaces including acoustic liner applications with sensors that: *(1) Are robust, (2) Reduce complexity for integration into a wind tunnel model, (3) Enable measurement in 360°.*

# Previous Micropillar Shear Stress Sensors

## W. Schröder, RWTH Aachen University

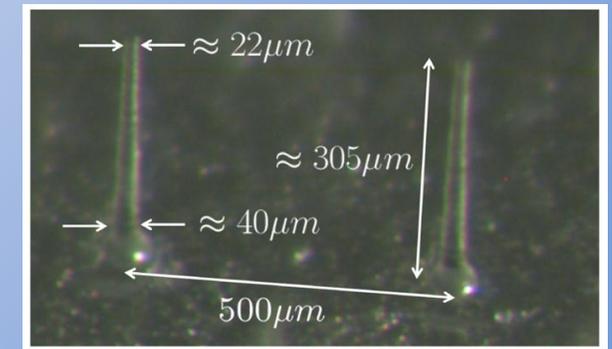
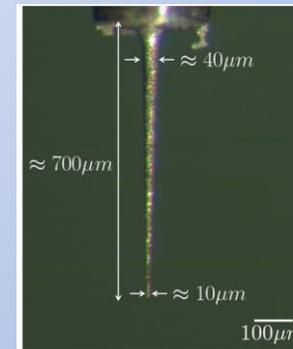


S. Große and W. Schröder *Int. J. Heat and Fluid Flow* **2008**, 29, 830.

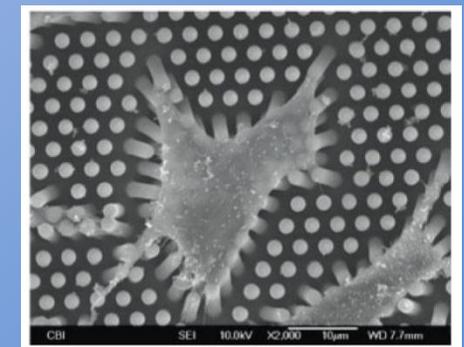
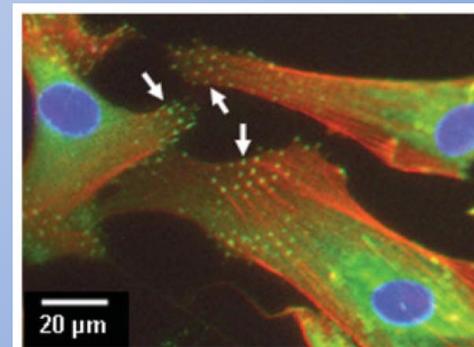
S. Große, et. al. *Meas. Sci. Technol.* **2006**, 17, 2689.

## Other Research

### Novel Manufacturing Methods



### Investigation of Bio-adhesion



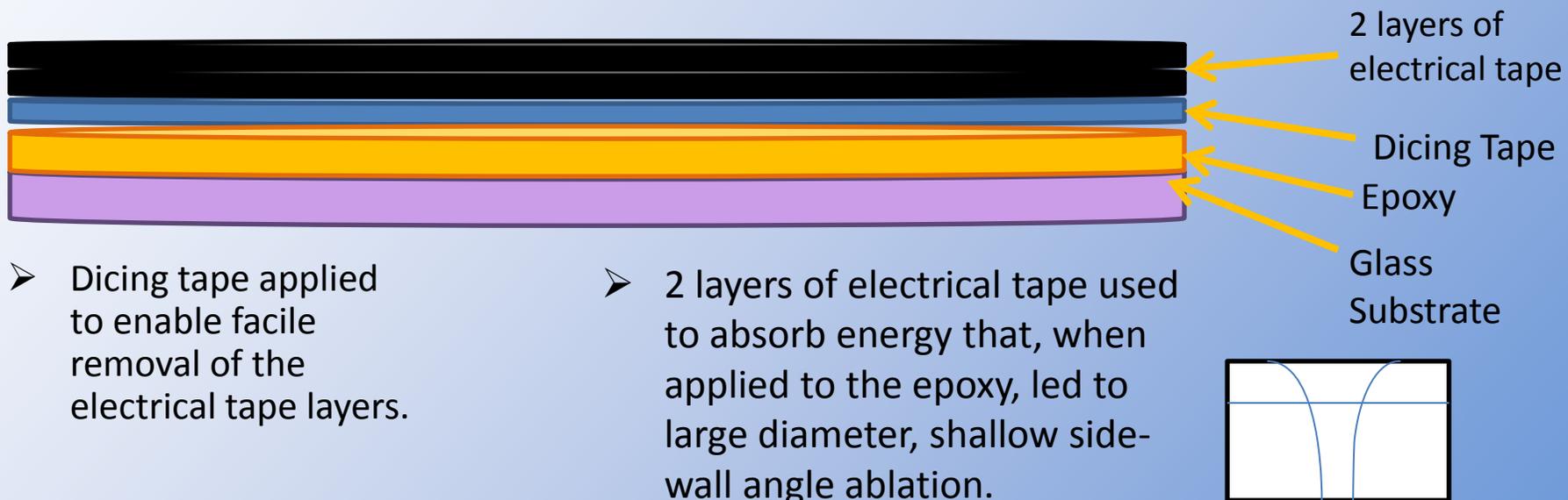
E. Gnanamanickam and J. Sullivan *J. Micromech. Microeng.* **2012**, 22, 125015.

B. Li, et. al. *Cell Motil. Cytoskeleton* **2007**, 64, 509.



# Laser Ablation for Template Generation

- Generation of master templates amenable to micropillar array fabrication: laser ablation patterning

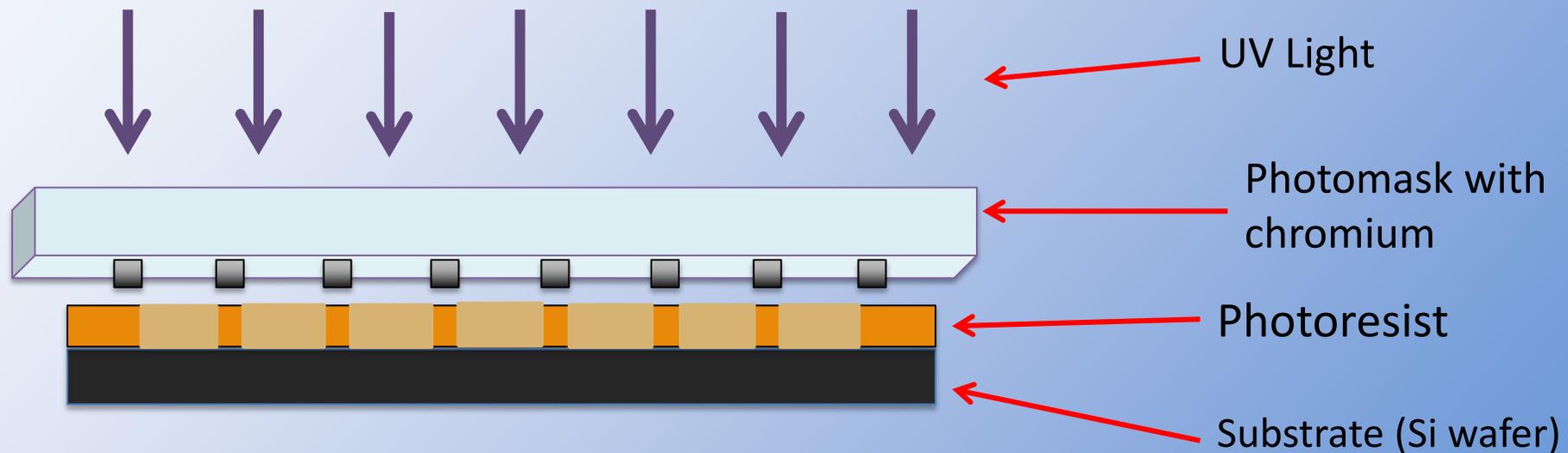


Laser ablation patterning affords excellent depth control but has limited diameter control with a minimum achievable diameter of approximately 30  $\mu\text{m}$ .



# Contact Lithography for Template Generation

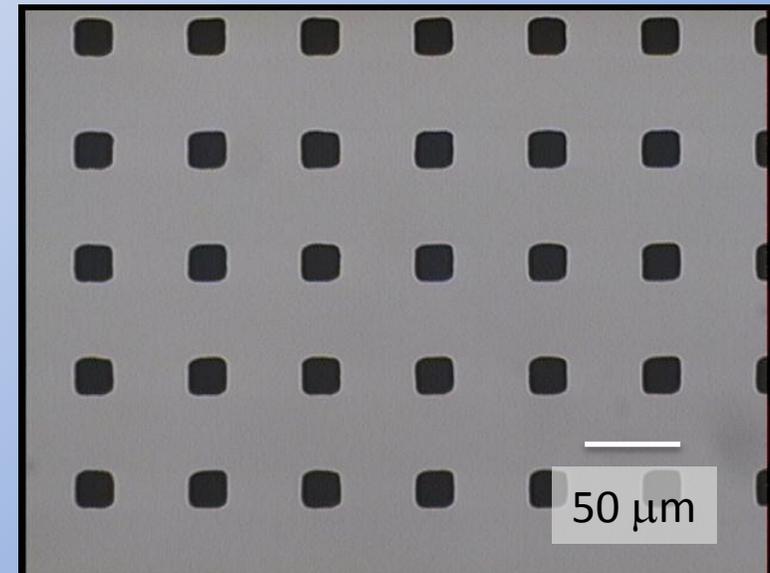
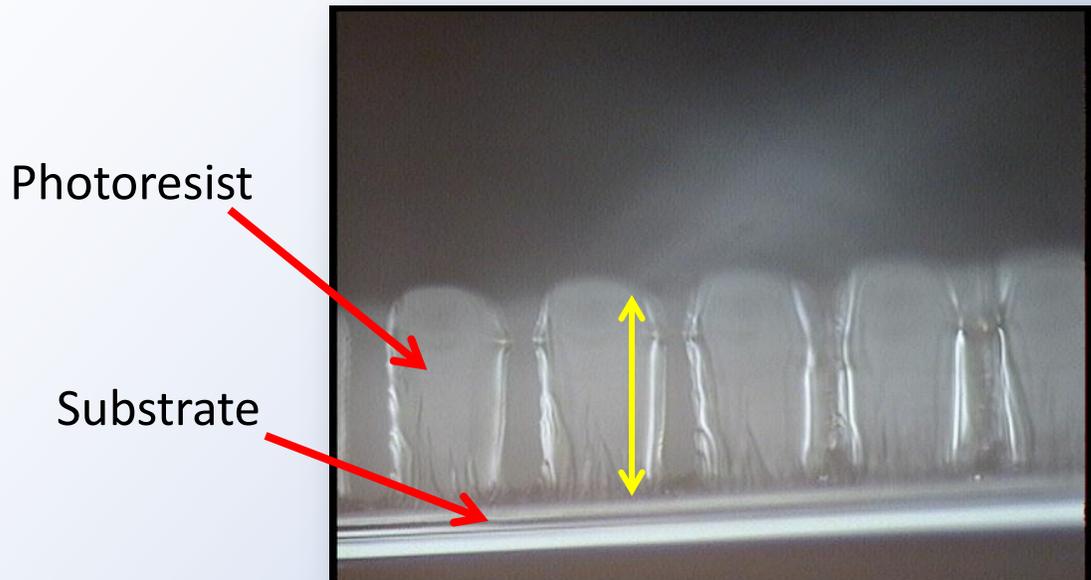
- Generation of master templates amenable to micropillar array fabrication: contact lithography





# Contact Lithography for Template Generation

- Generation of master templates amenable to micropillar array fabrication: contact lithography



Photolithography offers greater capability for increased aspect ratios relative to laser ablation patterning. However, the available photomask patterns are far too dense.

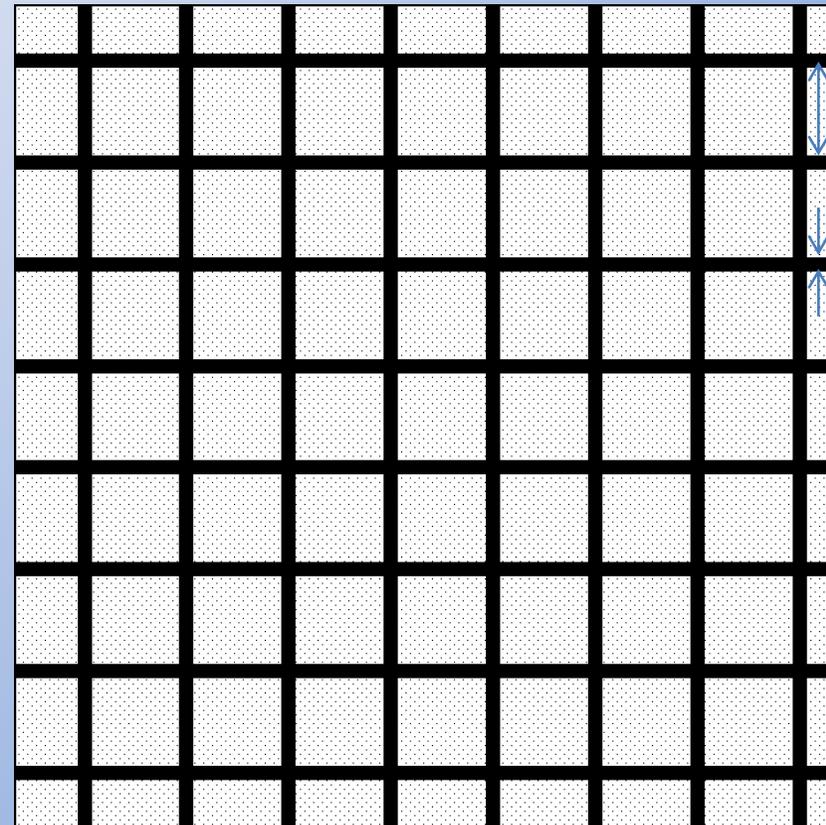


# Contact Lithography for Template Generation

Designed Photomask for Contact Lithography Master  
Template Fabrication



Close-up of Pattern Schematic

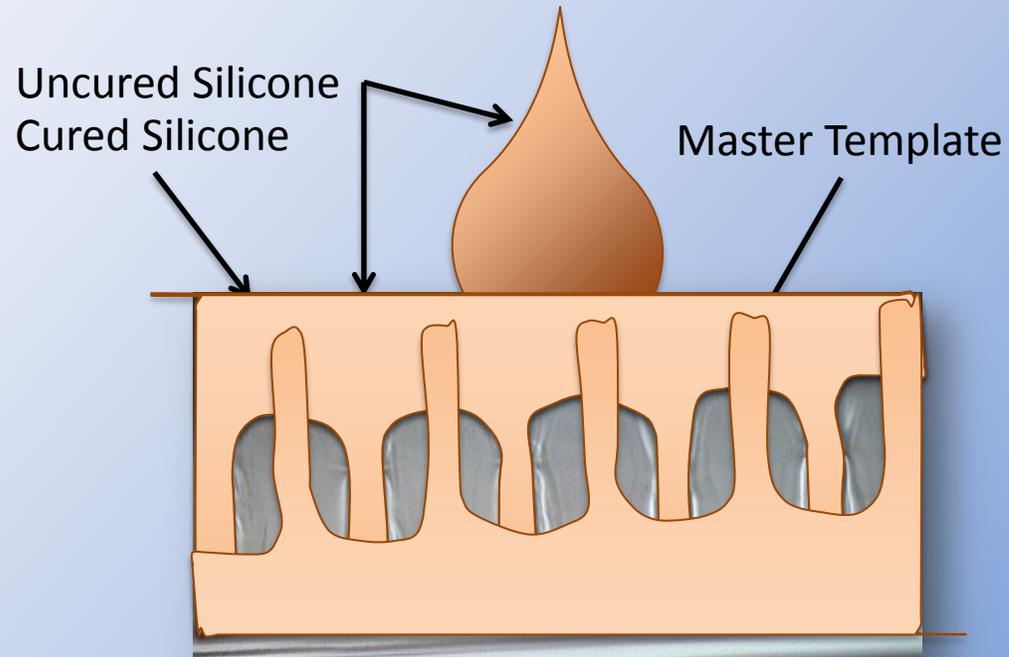


Pitch of stress-relief  
grid: 2 mm

Width of grid  
lines: 0.1 mm

# Micropillar Array Fabrication: Soft Lithography

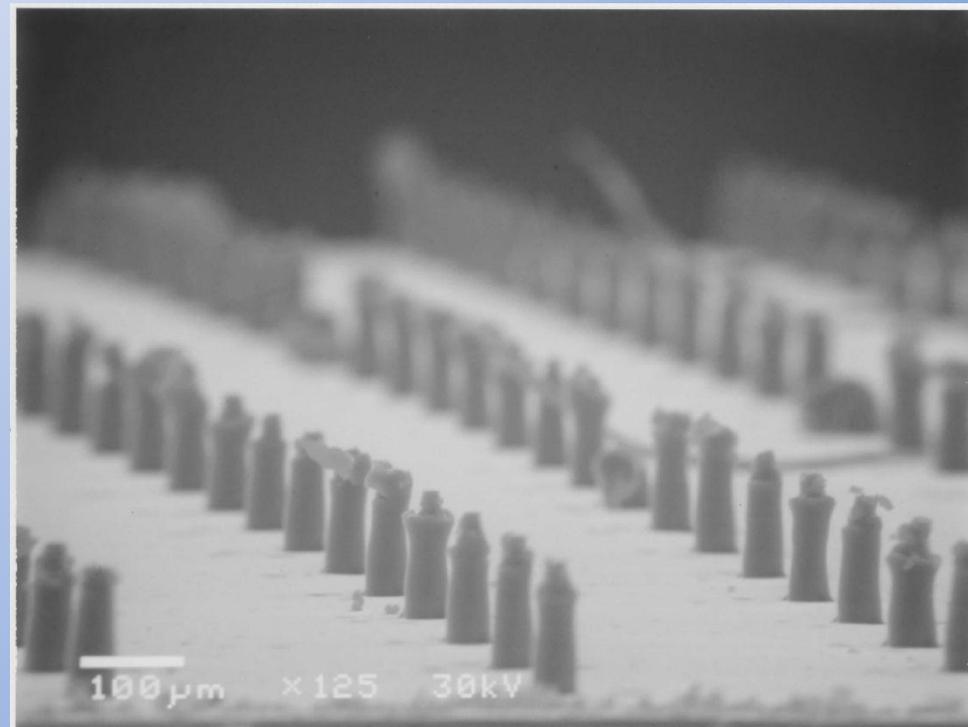
- Fabrication of micropillar arrays using soft lithographic techniques

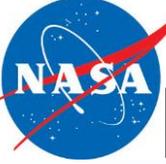


# NASA Micropillar Array Fabrication: Soft Lithography

- Fabrication of micropillar arrays using soft lithographic techniques: using laser ablation generated templates

% power	kHz	in/s	Post Height ( $\mu\text{m}$ )
90	60	2.5	115
90	60	2.0	123
92	60	3.0	62
92	60	2.5	45 - 85
92	60	2.0	132
95	60	3.0	85
95	60	2.5	123

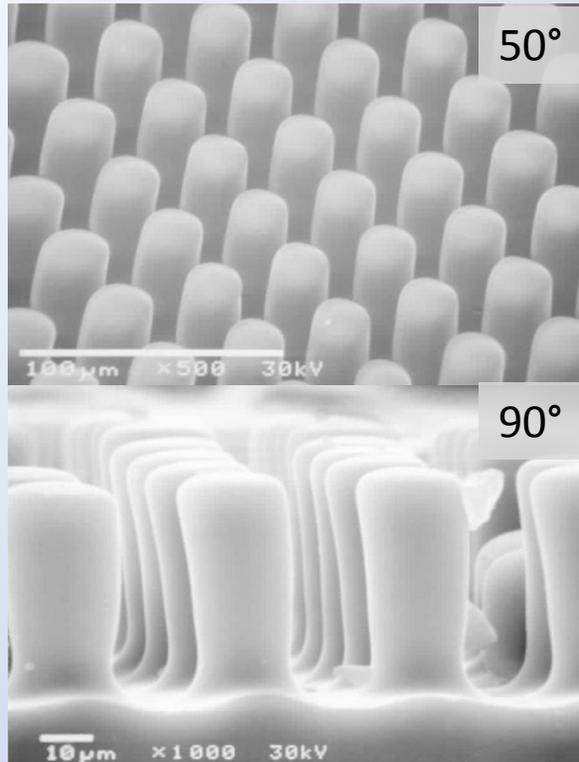




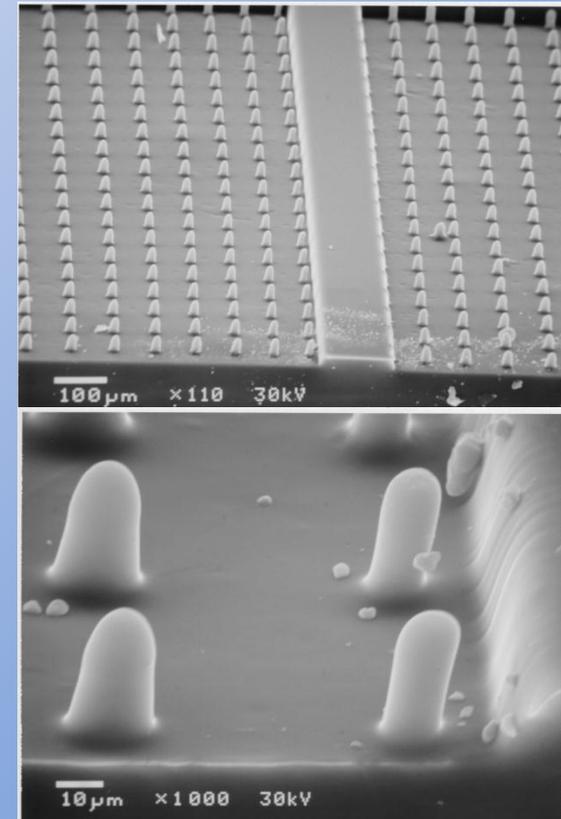
# Micropillar Array Fabrication: Soft Lithography

- Fabrication of micropillar arrays using soft lithographic techniques: using contact lithography templates

Results from  
old Photomask  
45-50  $\mu\text{m}$



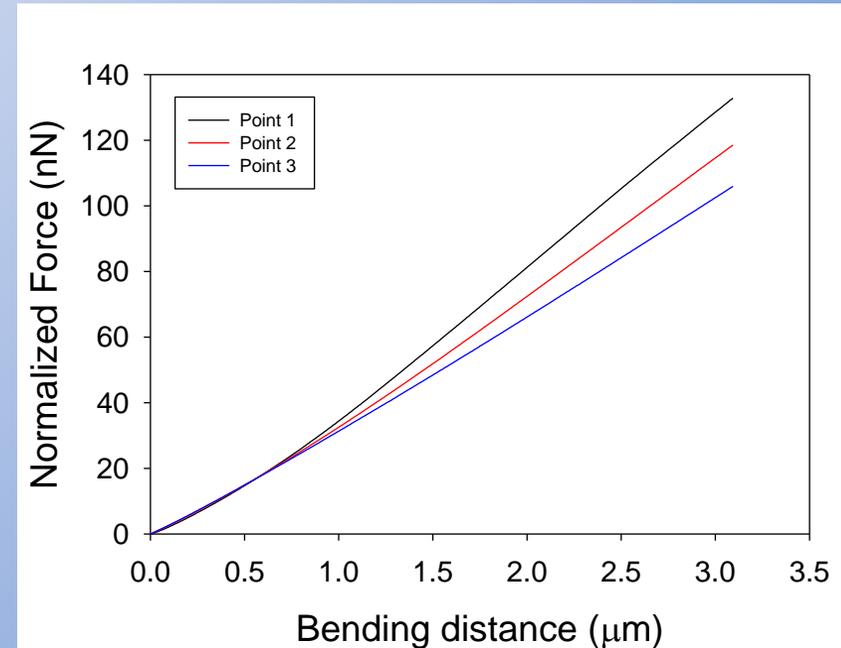
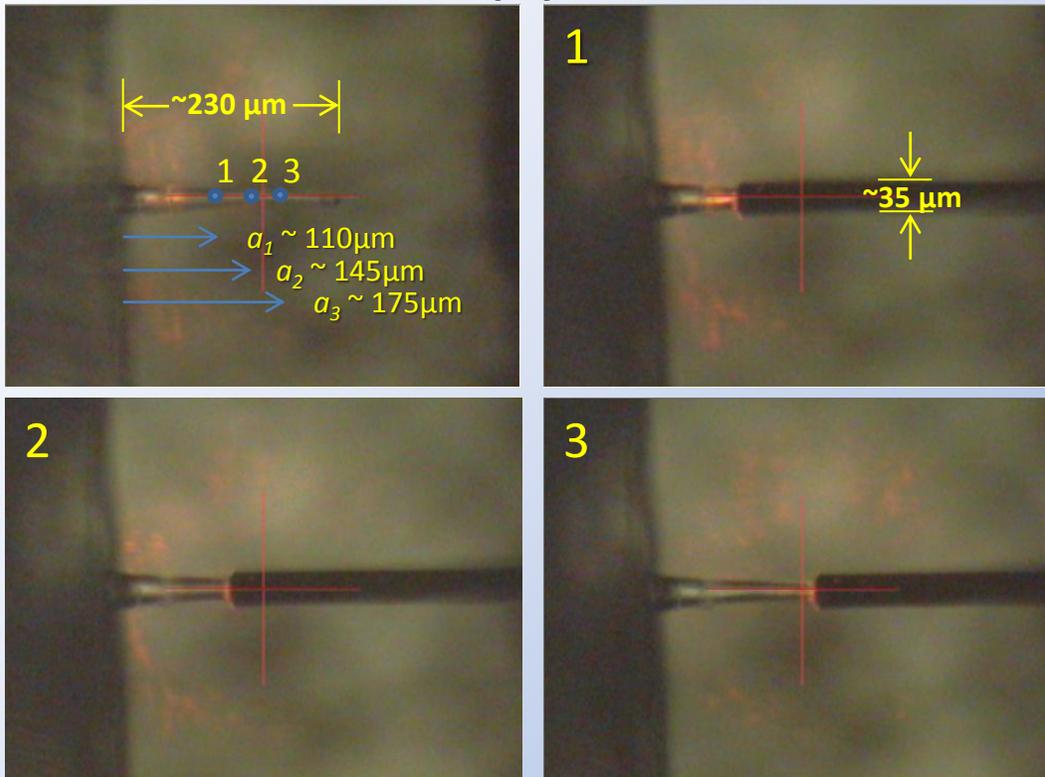
Results from  
New Photomask  
Aspect Ratio: 4:1





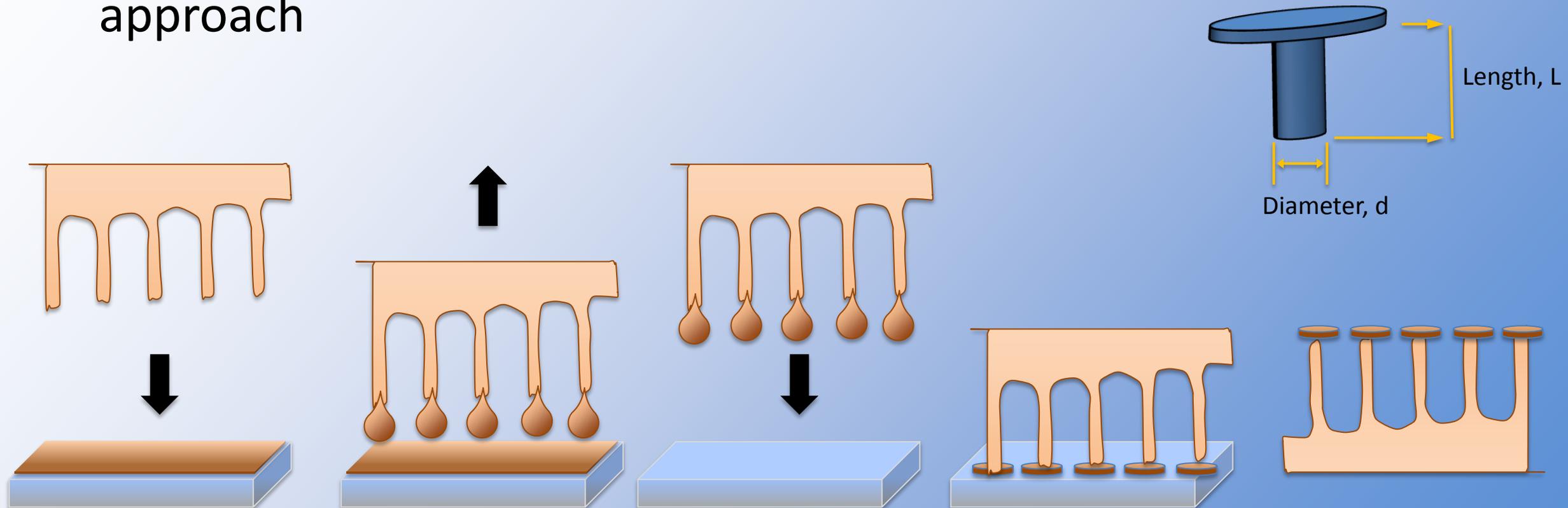
# Force Calibration of Micropillars

- Force-displacement pillar calibration experiments using atomic force microscopy



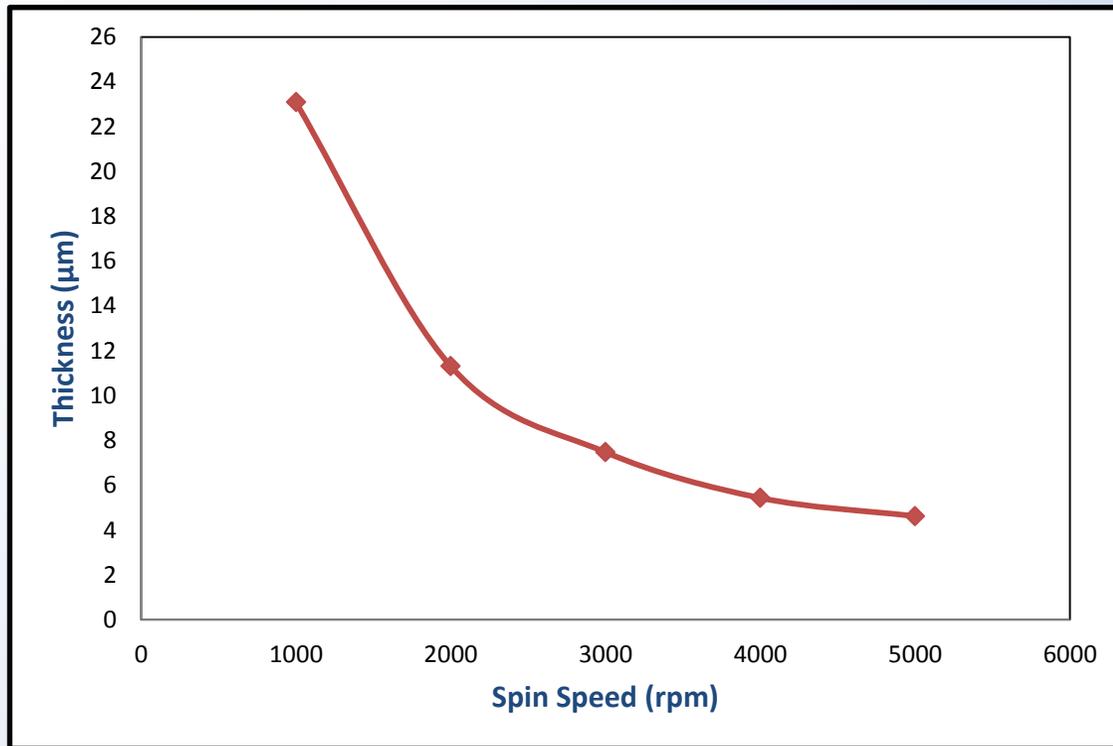
# “Capping” Micropillar Arrays

- Fabrication of “capped” micropillar arrays: schematic of approach

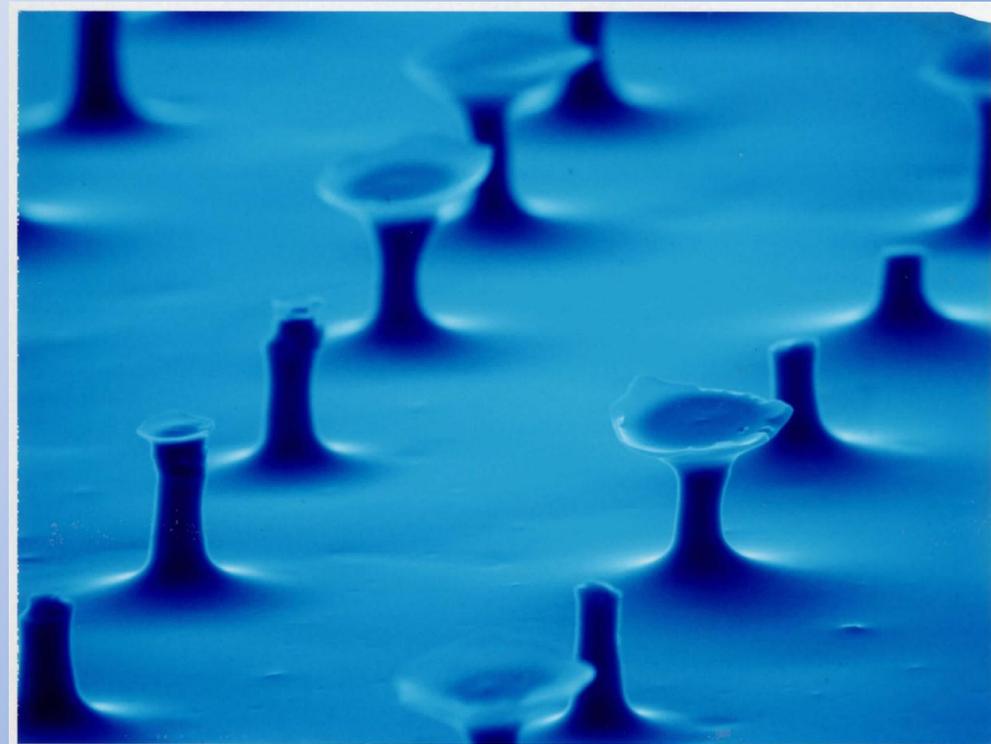


# “Capping” Micropillar Arrays

## Sylgard 184 Spin Curve



## SEM Image of “Capped” Pillars



“Cap” film thickness can be easily varied based on spin-coater settings. With greater pillar spacing, the caps readily formed and were free standing, i.e., no pillar coupling.



# Future Work

- Micropillar array design refinement
  - Identification of greatest efficacy methods for micropillar capping and signal enhancing dopant
  - Characterize micropillar deflection
  - Develop micropillar arrays for various wind speeds
- Characterization for signal implementation
  - Determine measurement range, sensitivity, noise floor, etc.
- Use of PIV equipment and visualization techniques to see pillar deflection



# Acknowledgements

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  - John Hopkins-Ablation Laser Operations
  - Vincent Cruz-Contact Lithography Assistance
- Discussion
  - Xiaoning Jiang, North Carolina State University
- Funding:
  - NASA Aeronautics Research Directorate NARI Seedling Program



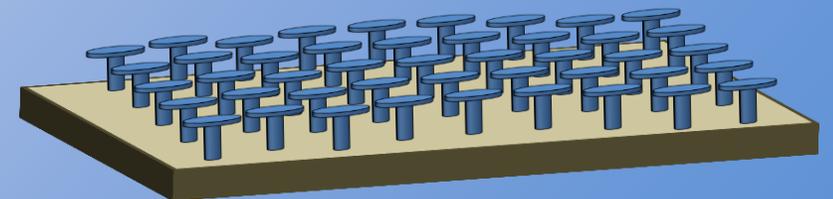
# Supplementary Slides

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# Experimental Approach

- Pillar Array Design and Fabrication
  - Generate master templates using available lithographic processes Identify requisite pillar parameters for shear stress measurements in subsonic flows
    - Laser ablation of epoxy substrates
    - Contact lithography of SU-8 coated Si wafers
  - Fabricate micropillar arrays using commercially available elastomeric materials
- Pillar Calibration and Signal Transduction
  - Calibrate pillar deflection using atomic force microscopy
  - Determine signal transduction approach

Pillar Parameter	Value
Length, $L$	$L < 100 \mu\text{m}$
Aspect Ratio, $L/d$ (diameter)	$L/d \geq 3$
Pillar Spacing, $s$	$s > 2L$
Deflection Limit, $w$	$w \leq 0.1L$

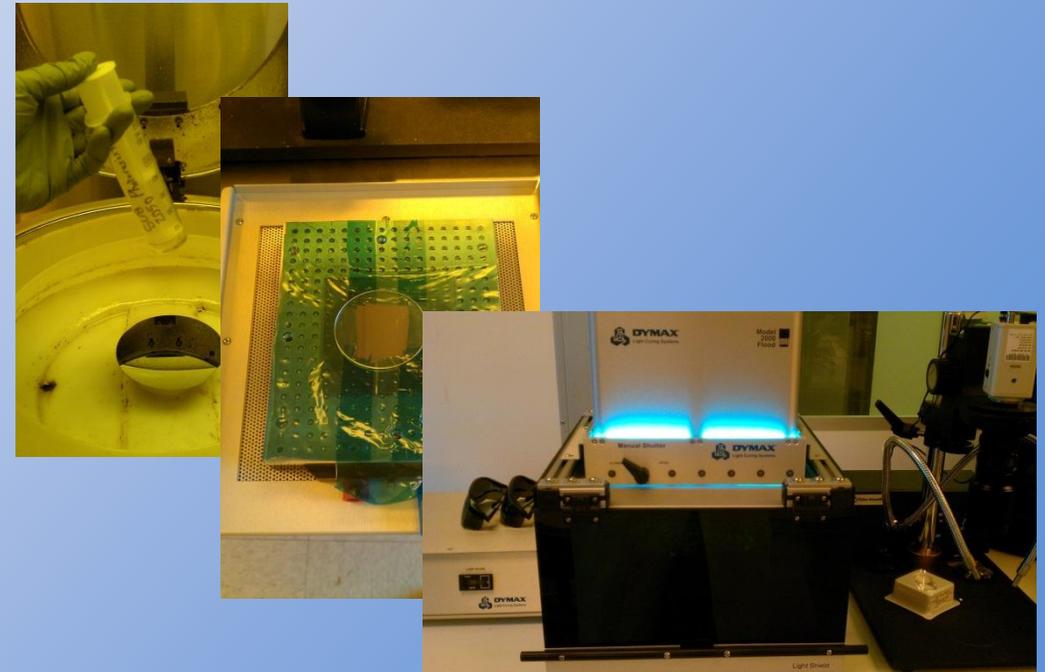


Concept



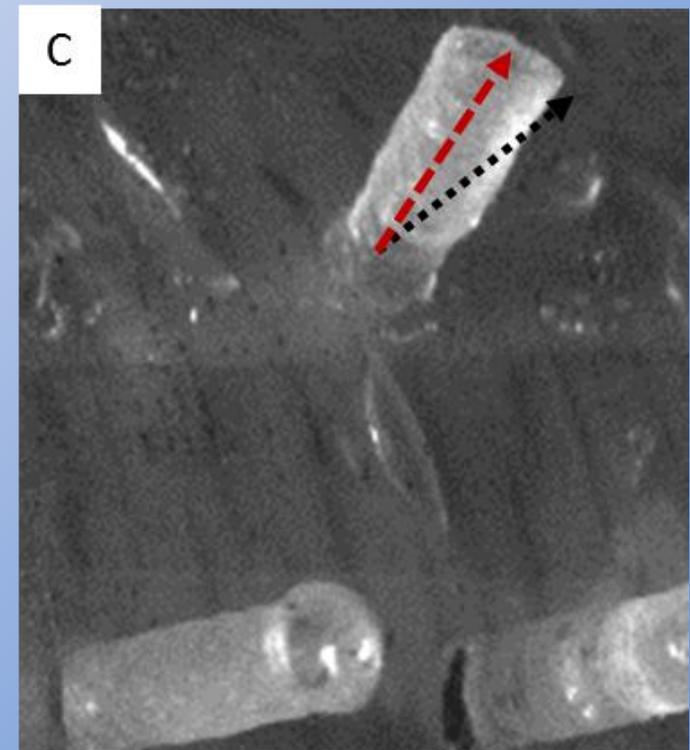
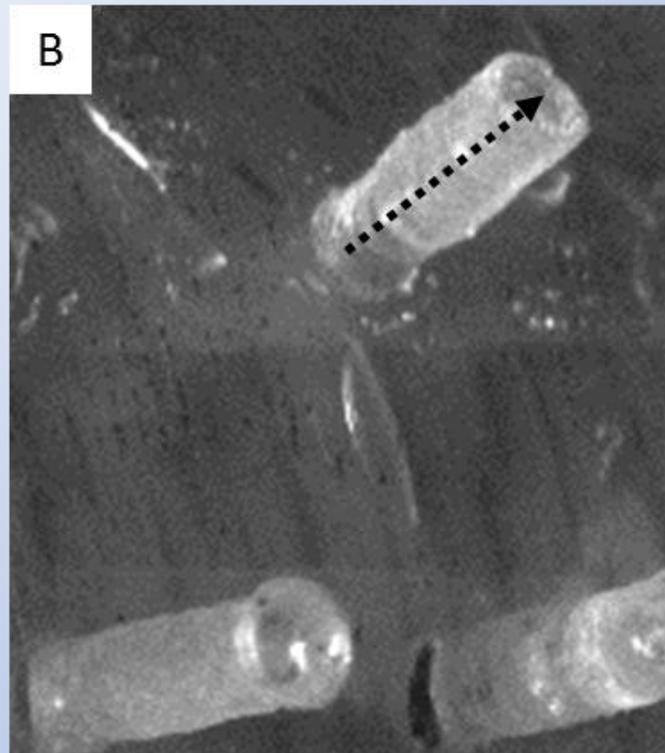
# Contact Lithography for Template Generation

- Generation of master templates amenable to micropillar array fabrication: contact lithography
  - This procedure required process refinement for several steps:
    - Plasma exposure of Si wafers
    - Dehydration baking
    - SU-8 adhesion promotion layer
    - SU-8 application
    - Soft bake
    - Photomask positioning and exposure
    - Pattern development



# Accomplishments

- Generation of a macroscopic example of the micropost array sensor

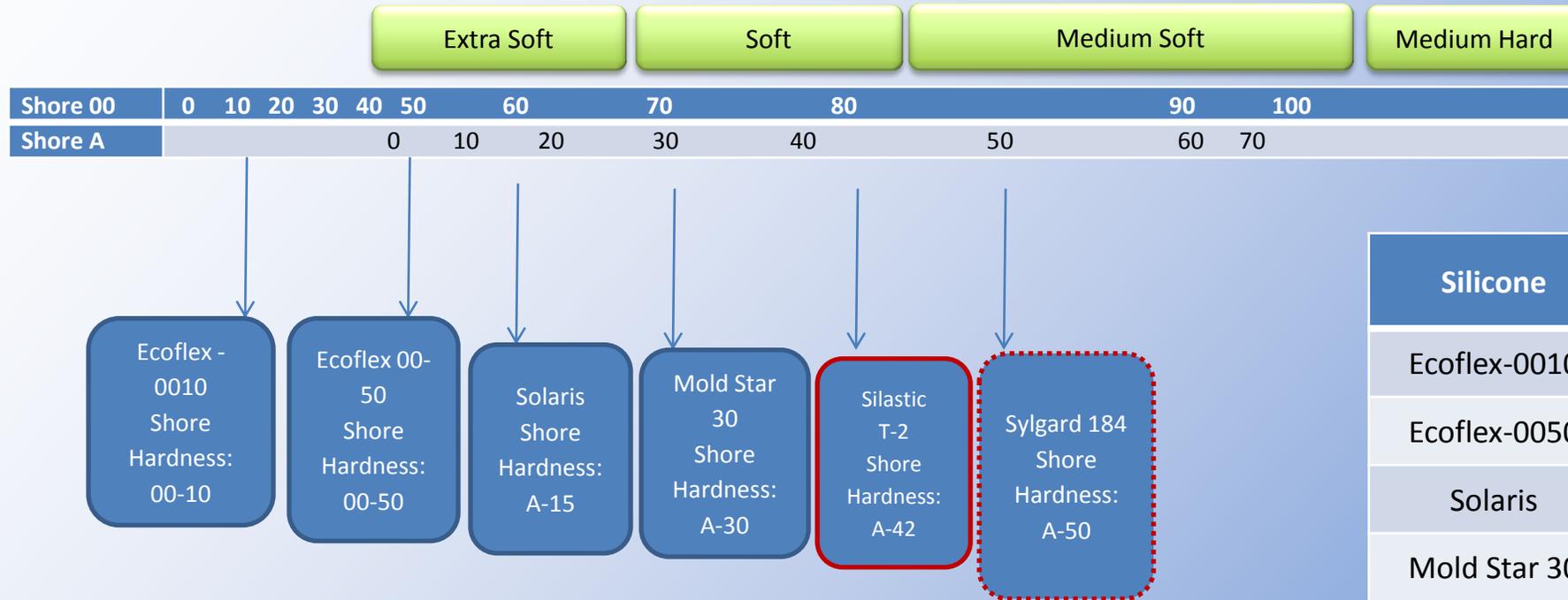


Pillar deflection was readily observed on the macroscopic sample.



# Micropillar Array Fabrication: Soft Lithography

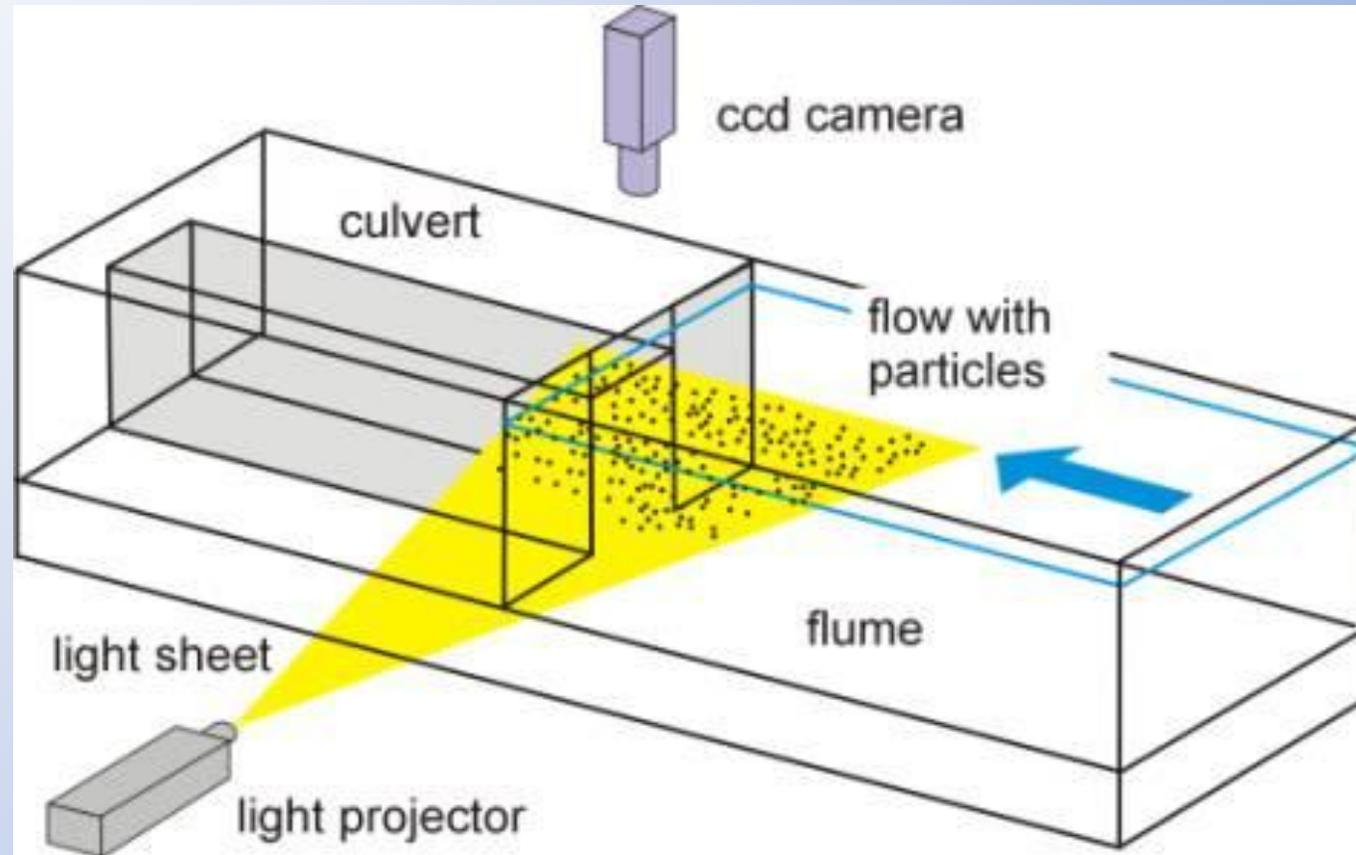
- Evaluation of different silicones



Silicone	Hardness (Shore A)	Tensile Strength (MPa)
Ecoflex-0010	00-10	0.83
Ecoflex-0050	00-50	2.17
Solaris	15	1.24
Mold Star 30	30	2.90
Silastic T2	42	5.52
Sylgard 184	50	7.07

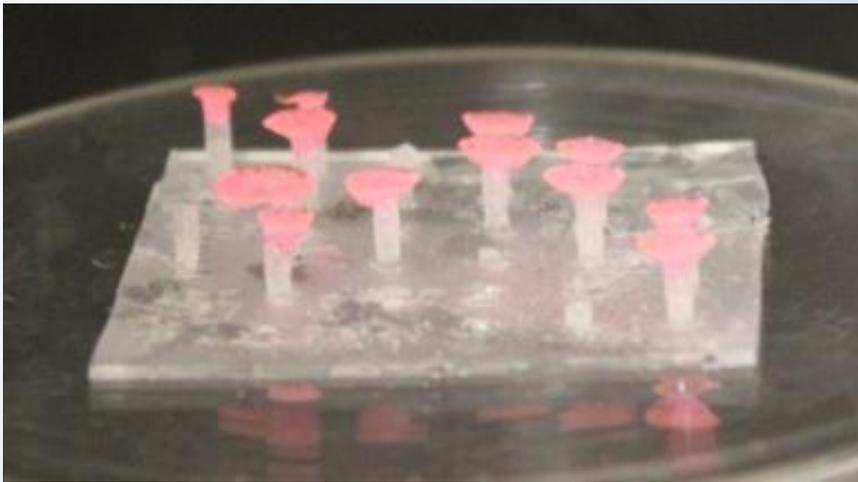
# Signal Transduction

- **Integration of Micropillar Array Sensors with Existing (Micro) Particle Image Velocimetry Instrumentation**

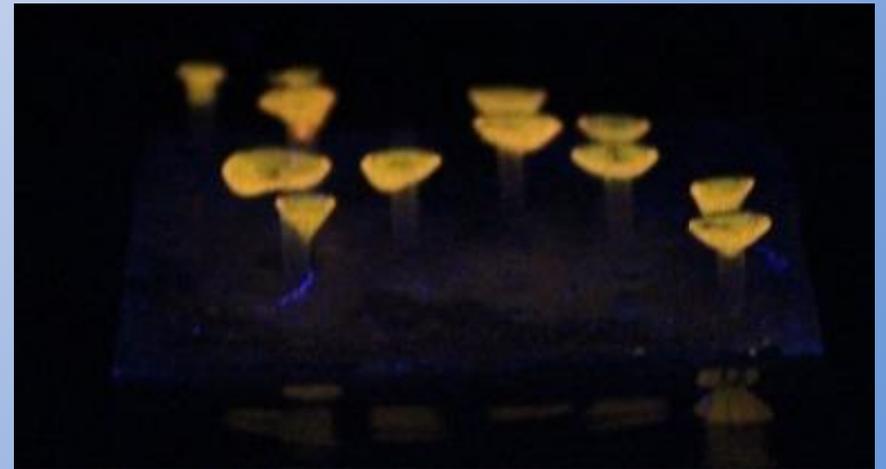


# Fluorescent Dye Doping of “Caps”

- Identification of most efficacious method for signal transduction: optical, piezoelectric, etc.



Visible Light Illumination



UV Light Illumination